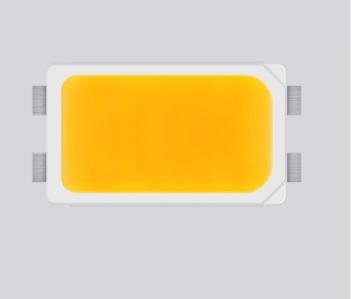
Middle Power LED Series 5630

LM561B Plus CRI90



Improved efficacy and performance of LM561B to provide better solution







Features & Benefits

- 0.3 W class middle power LED
- Mold resin for high reliability
- Standard form factor for design flexibility (5.6 × 3.0 mm)

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1. Characteristics

a) Absolute Maximum Rating

ltem	Symbol	Rating	Unit	Condition
Ambient / Operating Temperature	Ta	-40 ~ + 85	°C	-
Storage Temperature	T_{stg}	-40 ~ +120	°C	-
LED Junction Temperature	Tj	110	°C	-
Forward Current	lF	180	mA	-
Peak Pulsed Forward Current	l _{fp}	300	mA	Duty 1/10, pulse width 10 ms
Assembly Process Temperature	-	260 <10	°C s	-
ESD (HBM)	-	±5	kV	-

b) Electro-optical Characteristics (I_F = 65 mA, T_s = 25 °C)

ltem	Unit	CRI (R₃) Min.	Nominal CCT (K)	Rank	Bin	Min.	Тур.	Max.
					AZ	2.7	-	2.8
					A1	2.8	-	2.9
Forward Voltage (V _F)	V			WA	A2	2.9	-	3.0
					A3	3.0	-	3.1
					A4	3.1	-	3.2
					S1	24.0	-	26.0
			2700		S2	26.0		28.0
					S3	28.0		30.0
					S1	24.5	-	26.5
			3000		S2	26.5		28.5
					S3	28.5		30.5
					S1	25.0	-	27.0
			3500		S2	27.0	-	29.0
			4000		S3	29.0	-	31.0
	lm	90			S1	26.0		28.0
Luminous Flux (Φ _ν)					S2	28.0	-	30.0
					S3	30.0	-	32.0
					S1	27.0	-	29.0
			5000		S2	29.0	-	31.0
					S3	31.0	-	33.0
					S1	26.5		28.5
			5700		S2	28.5	-	30.5
					S3	30.5	-	32.5
					S1	26.0		28.0
			6500		S2	28.0		30.0
					S3	30.0		32.0
Reverse Voltage (@ 5 mA)	V					0.7	-	1.2
Color Rendering Index (Ra)	-					90	-	-
Special CRI (R9)	-					50	-	-
Thermal Resistance (junction to solder point)	°C/W					-	15	-
Beam Angle	0					-	120	-

Note:

Samsung maintains measurement tolerance of: forward voltage = ± 0.1 V, luminous flux = ± 5 %, CRI = ± 3 , R9 = ± 6.5

2. Product Code Information

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18
S	Р	M	W	Н	Т	5	4	1	М	Р	7	W	Α	R	0	S	1

Digit	PKG Information	Code			Specification
1 2 3	Samsung Package Middle Power	SPM			
4 5	Color	WH	White		
6	Product Version	Т			
7 8 9	Form Factor	541	5.6 x 3.0 x	0.7 mm;	4 pads;
10	Sorting Current (mA)	M	65 mA		
11	Chromaticity Coordinates	Р			
12	CRI	7	Min. 90		
13 14	Forward Voltage (V)	WA	2.7~3.2V	(2,500 p	cs/Reel)
15 16	CCT (K)	W☆ V☆ U☆ T☆ R☆ Q☆	2700 3000 3500 4000 5000 5700 6500 ☆ "0" (V	Bin Code:	W1, W2, W3, W4, W5, W6, W7, W8, W9, WA, WB, WC, WD, WE, WF, WG V1, V2, V3, V4, V5, V6, V7, V8, V9, VA, VB, VC, VD, VE, VF, VG U1, U2, U3, U4, U5, U6, U7, U8, U9, UA, UB, UC, UD, UE, UF, UG T1, T2, T3, T4, T5, T6, T7, T8, T9, TA, TB, TC, TD, TE, TF, TG R1, R2, R3, R4, R5, R6, R7, R8, R9, RA, RB, RC, RP, RQ, RR, RS Q1, Q2, Q3, Q4, Q5, Q6, Q7, Q8, Q9, QA, QB, QC, QP, QQ, QR, QS P1, P2, P3, P4, P5, P6, P7, P8, P9, PA, PB, PC, PP, PQ, PR, PS "M" (Quarter bin) "K" (K Kitting) or "S" (S Kitting)
17 18	Luminous Flux	S0		Bin Code:	S1, S2, S3

a) Luminous Flux Bins($I_F = 65 \text{ mA}$, $T_s = 25^{\circ}\text{C}$)

CRI (R _a) Min.	Nominal CCT (K)	Product Code	Flux Bin	Flux Range (Φ _v , lm)
			S1	24.0 ~ 26.0
	2700	SPMWHT541MP7WAW☆S0	S2	26.0 ~ 28.0
			S3	28.0 ~ 30.0
			S1	24.5 ~ 26.5
	3000	SPMWHT541MP7WAV☆S0	S2	26.5 ~ 28.5
			S3	28.5 ~ 30.5
			S1	25.0 ~ 27.0
	3500	SPMWHT541MP7WAU☆S0	S2	27.0 ~ 29.0
			S3	29.0 ~ 31.0
	4000		S1	26.0 ~28.0
90		SPMWHT541MP7WAT☆S0	S2	28.0 ~30.0
			\$3	30.0 ~32.0
			S1	27.0 ~ 29.0
	5000	SPMWHT541MP7WAR☆S0	S2	29.0 ~ 31.0
			\$3	31.0 ~ 33.0
			S1	26.5 ~ 28.5
	5700	SPMWHT541MP7WAQ☆S0	S2	28.5 ~ 30.5
			S3	30.5 ~ 32.5
			S1	26.0 ~ 28.0
	6500	SPMWHT541MP7WAP☆S0	S2	28.0 ~ 30.0
			S3	30.0 ~ 32.0
Note:				

Note:

[&]quot; \spadesuit " can be "A" (2,500pcs) of reel taping

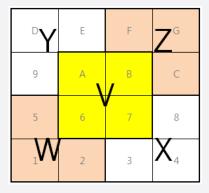
 $^{^{&}quot;}$ $^{"}$ can be "0" (Whole bin), "M" (Quarter bin), "K" (K Kitting) or "S" (S Kitting) of the color binning

b) Kitting rule

1) K Kitting bin Concept

- 1. Under agreement between customer and SAMSUNG ELECTRONICS, SAMSUNG can supply kitting bin (VF, Color, Im).
- 2. A forward voltage (VF) of kitting bin is combined by a pair of same VF rank such as (A1+A1), (A2+A2), (A3+A3), (A4+A4) or (AZ+AZ).
- 3. A Chromaticity Coordinates of kitting bin is mixed by kitting procedure.(below kitting simulation)
- 4. A luminous flux(lm) of kitting bin is combined by a pair of IV rank such as (S1+S1), (S2+S2) or (S3+S3)

[Kitting example ; Warm white] (2700K, 3000K, 3500K, 4000K)



[Kitting example ; Cool white] (5000K, 5700K, 6500K)

٩Y	Α	В	Z ^c
5	6	7	8
1	2	3	4
ρV	Q	R	X s

[Binning Information]

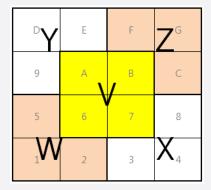
	Warm	n white	Cool	white
	Bin #1	Bin #2	Bin #1	Bin #2
	AZ	AZ	AZ	AZ
	A1	A1	A1	A1
VF	A2	A2	A2	A2
	A3	A3	A3	A3
	A4	A4	A4	A4
	W (1, 2, 5, 6 bin)	Z (B, C, F, G bin)	W (1, 2, P, Q bin)	Z (7, 8, B, C bin)
CIE	V (6, 7, A, B bin)	V (6, 7, A, B bin)	V (2, 3, 6, 7 bin)	V (2, 3, 6, 7 bin)
	X (3, 4, 7, 8 bin)	Y (9, A, D, E bin)	X (3, 4, R, S bin)	Y (5, 6, 9, A bin)
	S1	S1	S1	S1
IV	S2	S2	S2	S2
	S3	S3	S3	S3

[※] Each of V,W,X,Y and Z can be one bin without details division

2) S Kitting bin Concept

- 1. Under agreement between customer and SAMSUNG ELECTRONICS, SAMSUNG can supply kitting bin (VF, Color, Im).
- 2. A forward voltage (VF) of kitting bin is combined by a pair of same VF rank such as (A1+A1), (A2+A2), (A3+A3), (A4+A4) or (AZ+AZ).
- 3. A Chromaticity Coordinates of kitting bin is mixed by kitting procedure.(below kitting simulation)
- 4. A luminous flux(lm) of kitting bin is combined by a pair of IV rank such as (S1+S1), (S2+S2) or (S3+S3)

[Kitting example ; Warm white] (2700K, 3000K, 3500K, 4000K)



[Kitting example ; Cool white] (5000K, 5700K, 6500K)

⁹ Y	Α	В	Z°
5	6	7	8
1	2	3	4
ρM	Q	R	X s

[Binning Information]

	Warm	white	Cool	white
	Bin #1	Bin #2	Bin #1	Bin #2
	AZ	AZ	AZ	AZ
	A1	A1	A1	A1
VF	A2	A2	A2	A2
	A3	A3	A3	A3
	A4	A4	A4	A4
	W (1, 2, 5)	В	W (1, P, Q)	7
	X (3, 4, 8)	A	X (4, R, S)	6
	Y (9, D, E)	7	Y (5, 9, A)	3
	Z (C, F, G)	6	Z (8, B, C)	2
CIE	6	6	2	2
	7	7	3	3
	Α	А	6	6
	В	В	7	7
	V (6, 7, A, B)	V (6, 7, A, B)	V (2, 3, 6, 7)	V (2, 3, 6, 7)
	S1	S1	S1	S1
IV	S2	S2	S2	S2
	S3	S3	S3	S3

[※] Each of V,W,X,Y and Z can be one bin without details division.

c) Color Bins ($I_F = 65 \text{ mA}$, $T_s = 25 \, {}^{\circ}\text{C}$)

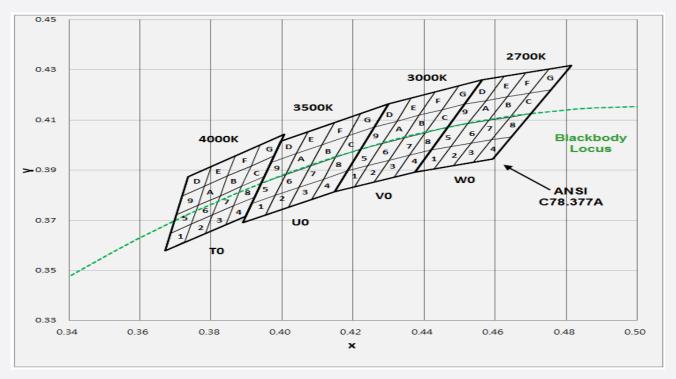
CRI (R _a) Min.	Nominal CCT (K)	Product Code	Color Rank	Chromaticity Bins
		SPMWHT541MP7WAW0S0	W0 (Whole bin)	W1, W2, W3, W4, W5, W6, W7, W8, W9, WA, WB, WC, WD, WE, WF, WG
	0700	SPMWHT541MP7WAWM0	WM (Quarter bin)	W6, W7, WA, WB
	2700	SPMWHT541MP7WAWSS0	WS (S Kitting)	W6, W7, WA, WB, WV, WW, WX, WY, WZ
		SPMWHT541MP7WAWK0	WK (K Kitting)	WV, WW, WX, WY, WZ
		SPMWHT541MP7WAV0S0	V0 (Whole bin)	V1, V2, V3, V4, V5, V6, V7, V8, V9, VA, VB, VC, VD, VE, VF, VG
	2000	SPMWHT541MP7WAVMS0	VM (Quarter bin)	V6, V7, VA, VB
	3000	SPMWHT541MP7WAVSS0	VS (S Kitting)	V6, V7, VA, VB , VV, VW, VX, VY, VZ
		SPMWHT541MP7WAVKS0	VK (K Kitting)	VV, VW, VX, VY, VZ
		SPMWHT541MP7WAU0S0	U0 (Whole bin)	U1, U2, U3, U4, U5, U6, U7, U8, U9, UA, UB, UC, UD, UE, UF, UG
		SPMWHT541MP7WAUMS0	UM (Quarter bin)	U6, U7, UA, UB
	3500	SPMWHT541MP7WAUSS0	US (S Kitting)	U6, U7, UA, UB , UV, UW, UX, UY, UZ
		SPMWHT541MP7WAUKS0	UK (K Kitting)	UV, UW, UX, UY, UZ
90		SPMWHT541MP7WAT0S0	T0 (Whole bin)	T1, T2, T3, T4, T5, T6, T7, T8, T9, TA, TB, TC, TD, TE, TF, TG
	4000	SPMWHT541MP7WATMS0	TM (Quarter bin)	T6, T7, TA, TB
	4000	SPMWHT541MP7WATSS0	TS (S Kitting)	T6, T7, TA, TB , TV, TW, TX, TY, TZ
		SPMWHT541MP7WATKS0	TK (K Kitting)	TV, TW, TX, TY, TZ
		SPMWHT541MP7WAR0S0	R0 (Whole bin)	R1, R2, R3, R4, R5, R6, R7, R8, R9, RA, RB, RC, RP, RQ, RR, RS
	5000	SPMWHT541MP7WARMS0	RM (Quarter bin)	R2, R3, R6, R7
	5000	SPMWHT541MP7WARSS0	RS (S Kitting)	R2, R3, R6, R7, RW, RX, RY, RZ
		SPMWHT541MP7WARKS0	RK (K Kitting)	RV, RW, RX, RY, RZ
		SPMWHT541MP7WAQ0S0	Q0 (Whole bin)	Q1, Q2, Q3, Q4, Q5, Q6, Q7, Q8, Q9, QA, QB, QC, QP, QQ, QR, QS
		SPMWHT541MP7WAQMS0	QM (Quarter bin)	Q2, Q3, Q6, Q7
	5700	SPMWHT541MP7WAQSS0	QS (S Kitting)	Q2, Q3, Q6, Q7, QW, QX, QY, QZ
		SPMWHT541MP7WAQKS0	QK (K Kitting)	QV, QW, QX, QY, QZ

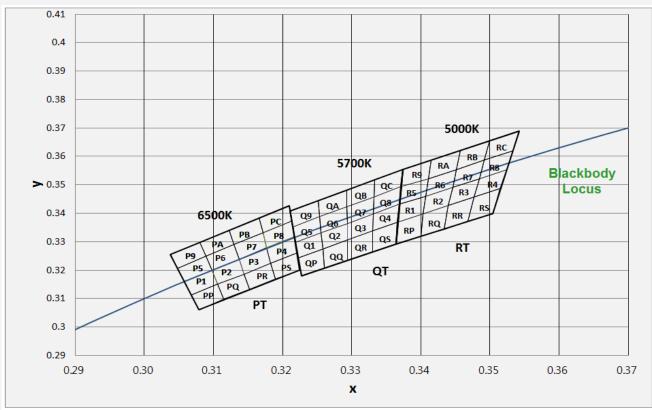
	SPMWHT541MP7WAP0S0	P0 (Whole bin)	P1, P2, P3, P4, P5, P6, P7, P8, P9, PA, PB, PC, PP, PQ, PR, PS
0500	SPMWHT541MP7WAPMS0	PM (Quarter bin)	P2, P3, P6, P7
6500	SPMWHT541MP7WAPSS0	PS (S Kitting)	P2, P3, P6, P7, PW, PX, PY, PZ
	SPMWHT541MP7WAPKS0	PK (K Kitting)	PV, PW, PX, PY, PZ

d) Voltage Bins (I_F = 65 mA, T_s = 25 °C)

CRI (R _a) Min.	Nominal CCT (K)	Product Code	Voltage Rank	Voltage Bin	Voltage Range (V)
				AZ	2.7 ~ 2.8
				A1	2.8 ~ 2.9
-	-	-	WA	A2	2.9 ~ 3.0
				АЗ	3.0 ~ 3.1
				A4	3.1 ~ 3.2

e) Chromaticity Region & Coordinates (I_F = 65 mA, T_s = 25 °C)





e) Chromaticity Region & Coordinates (IF = 65 mA, $T_{\rm s}$ = 25 °C)

Region	CIE x	CIE y	Region	CIE x	CIE y
		W rank	(2700 K)		
	0.4373	0.3893		0.4465	0.4071
W1	0.4418	0.3981	14/0	0.4513	0.4164
VVI	0.4475	0.3994	W9	0.4573	0.4178
	0.4428	0.3906		0.4523	0.4085
	0.4428	0.3906		0.4523	0.4085
14/0	0.4475	0.3994	10/0	0.4573	0.4178
W2	0.4532	0.4008	WA	0.4634	0.4193
	0.4483	0.3919		0.4582	0.4099
	0.4483	0.3919		0.4582	0.4099
1440	0.4532	0.4008		0.4634	0.4193
W3	0.4589	0.4021	WB	0.4695	0.4207
	0.4538	0.3931		0.4641	0.4112
	0.4538	0.3931	wc	0.4641	0.4112
	0.4589	0.4021		0.4695	0.4207
W4	0.4646	0.4034		0.4756	0.4221
	0.4593	0.3944		0.4700	0.4126
	0.4418	0.3981		0.4513	0.4164
	0.4465	0.4071		0.4562	0.4260
W5	0.4523	0.4085	WD	0.4624	0.4274
	0.4475	0.3994		0.4573	0.4178
	0.4475	0.3994		0.4573	0.4178
	0.4523	0.4085		0.4624	0.4274
W6	0.4582	0.4099	WE	0.4687	0.4289
	0.4532	0.4008		0.4634	0.4193
	0.4532	0.4008		0.4634	0.4193
	0.4582	0.4099		0.4687	0.4289
W7	0.4641	0.4112	WF	0.4750	0.4304
	0.4589	0.4021		0.4695	0.4207
	0.4589	0.4021		0.4695	0.4207
	0.4641	0.4112		0.4750	0.4304
W8	0.4700	0.4126	WG	0.4813	0.4319
	0.4646	0.4034		0.4756	0.4221

Region	CIE x	CIE y	Region	CIE x	CIE y				
	V rank (3000 K)								
	0.4147	0.3814		0.4221	0.3984				
	0.4183	0.3898	\ \rac{1}{2}	0.4259	0.4073				
V1	0.4242	0.3919	V9	0.4322	0.4096				
	0.4203	0.3833		0.4281	0.4006				
	0.4203	0.3833		0.4281	0.4006				
\/O	0.4242	0.3919		0.4322	0.4096				
V2	0.4300	0.3939	VA	0.4385	0.4119				
	0.4259	0.3853		0.4342	0.4028				
	0.4259	0.3853		0.4342	0.4028				
\/0	0.4300	0.3939		0.4385	0.4119				
V3	0.4359	0.3960	VB	0.4449	0.4141				
	0.4316	0.3873		0.4403	0.4049				
	0.4316	0.3873		0.4403	0.4049				
	0.4359	0.3960	VC	0.4449	0.4141				
V4	0.4418	0.3981		0.4513	0.4164				
	0.4373	0.3893		0.4465	0.4071				
	0.4183	0.3898		0.4259	0.4073				
\/5	0.4221	0.3984		0.4299	0.4165				
V5	0.4281	0.4006	VD	0.4364	0.4188				
	0.4242	0.3919		0.4322	0.4096				
	0.4242	0.3919		0.4322	0.4096				
\/O	0.4281	0.4006		0.4364	0.4188				
V6	0.4342	0.4028	VE	0.4430	0.4212				
	0.4300	0.3939		0.4385	0.4119				
	0.4300	0.3939		0.4385	0.4119				
\/7	0.4342	0.4028	\/_	0.4430	0.4212				
V7	0.4403	0.4049	VF	0.4496	0.4236				
	0.4359	0.3960		0.4449	0.4141				
	0.4359	0.3960		0.4449	0.4141				
\/0	0.4403	0.4049	VO	0.4496	0.4236				
V8	0.4465	0.4071	VG	0.4562	0.4260				
	0.4418	0.3981		0.4513	0.4164				

e) Chromaticity Region & Coordinates

Region	CIE x	CIE y	Region	CIE x	CIE y
		U rank	(3500 K)		
	0.3889	0.3690		0.3941	0.3848
1.14	0.3915	0.3768	110	0.3968	0.3930
U1	0.3981	0.3800	U9	0.4040	0.3966
	0.3953	0.3720		0.4010	0.3882
	0.3953	0.3720		0.4010	0.3882
110	0.3981	0.3800	110	0.4040	0.3966
U2	0.4048	0.3832	UA	0.4113	0.4001
	0.4017	0.3751		0.4080	0.3916
	0.4017	0.3751		0.4080	0.3916
110	0.4048	0.3832		0.4113	0.4001
U3	0.4116	0.3865	UB	0.4186	0.4037
	0.4082	0.3782		0.4150	0.3950
	0.4082	0.3782		0.4150	0.3950
114	0.4116	0.3865	UC	0.4186	0.4037
U4	0.4183	0.3898		0.4259	0.4073
	0.4147	0.3814		0.4221	0.3984
	0.3915	0.3768		0.3968	0.3930
LIE	0.3941	0.3848	LID	0.3996	0.4015
U5	0.4010	0.3882	UD	0.4071	0.4052
	0.3981	0.3800		0.4040	0.3966
	0.3981	0.3800		0.4040	0.3966
LIG	0.4010	0.3882		0.4071	0.4052
U6	0.4080	0.3916	UE	0.4146	0.4089
	0.4048	0.3832		0.4113	0.4001
	0.4048	0.3832		0.4113	0.4001
117	0.4080	0.3916	HE	0.4146	0.4089
U7	0.4150	0.3950	UF	0.4222	0.4127
	0.4116	0.3865		0.4186	0.4037
	0.4116	0.3865		0.4186	0.4037
LIO	0.4150	0.3950	Ш	0.4222	0.4127
U8	0.4221	0.3984	UG	0.4299	0.4165
	0.4183	0.3898		0.4259	0.4073

Region	CIE x	CIE y	Region	CIE x	CIE y				
	T rank (4000 K)								
	0.3670	0.3578		0.3702	0.3722				
T1	0.3726	0.3612	Т9	0.3763	0.3760				
11	0.3744	0.3685	19	0.3782	0.3837				
	0.3686	0.3649 0.3719	0.3719	0.3797					
	0.3726	0.3612		0.3763	0.3760				
TO	0.3783	0.3646	Τ.	0.3825	0.3798				
T2	0.3804	0.3721	TA	0.3847	0.3877				
	0.3744	0.3685		0.3782	0.3837				
	0.3783	0.3646		0.3825	0.3798				
то.	0.3840	0.3681	TD	0.3887	0.3836				
T3	0.3863	0.3758	ТВ	0.3912	0.3917				
	0.3804	0.3721		0.3847	0.3877				
	0.3840	0.3681		0.3887	0.3837				
T4	0.3898	0.3716	тс	0.3950	0.3875				
14	0.3924	0.3794		0.3978	0.3958				
	0.3863	0.3758		0.3912	0.3917				
	0.3686	0.3649		0.3719	0.3797				
T-5	0.3744	0.3685	TD	0.3782	0.3837				
T5	0.3763	0.3760	TD	0.3802	0.3916				
	0.3702	0.3722		0.3736	0.3874				
	0.3744	0.3685		0.3782	0.3837				
Te	0.3804	0.3721		0.3847	0.3877				
T6	0.3825	0.3798	TE	0.3869	0.3958				
	0.3763	0.376		0.3802	0.3916				
	0.3804	0.3721		0.3847	0.3877				
T-7	0.3863	0.3758	TF	0.3912	0.3917				
T7	0.3887	0.3836	1F	0.3937	0.4001				
	0.3825	0.3798		0.3869	0.3958				
	0.3863	0.3758		0.3912	0.3917				
To	0.3924	0.3794	то	0.3978	0.3958				
Т8	0.3950	0.3875	TG	0.4006	0.4044				
	0.3887	0.3836		0.3937	0.4001				

e) Chromaticity Region & Coordinates

Region	CIE x	CIE y	Region	CIE x	CIE y
		R rank	(5000 K)		
	0.3366	0.3369		0.3374	0.3554
D4	0.3369	0.3431	DO	0.3371	0.3493
R1	0.3407	0.3460	R9	0.3411	0.3522
	0.3403	0.3398		0.3415	0.3587
	0.3403	0.3398		0.3415	0.3587
D.O.	0.3407	0.3460	D.4	0.3411	0.3522
R2	0.3446	0.3491	RA	0.3451	0.3554
	0.3440	0.3427		0.3457	0.3621
	0.3446	0.3491		0.3451	0.3554
	0.3440	0.3427		0.3457	0.3621
R3	0.3477	0.3458	RB	0.3500	0.3655
	0.3485	0.3522		0.3492	0.3587
	0.3485	0.3522		0.3492	0.3587
	0.3477	0.3458		0.3500	0.3655
R4	0.3514	0.3487	RC	0.3542	0.3690
	0.3524	0.3554		0.3533	0.3620
	0.3371	0.3493		0.3366	0.3369
	0.3369	0.3431		0.3364	0.3292
R5	0.3407	0.3460	RP	0.3400	0.3320
	0.3411	0.3522		0.3403	0.3398
	0.3407	0.3460		0.3403	0.3398
	0.3411	0.3522		0.3400	0.3320
R6	0.3451	0.3554	RQ	0.3434	0.3344
	0.3446	0.3491		0.3440	0.3427
	0.3446	0.3491		0.3440	0.3427
	0.3451	0.3554		0.3434	0.3344
R7	0.3492	0.3587	RR	0.3468	0.3372
	0.3485	0.3522		0.3477	0.3458
	0.3485	0.3522		0.3477	0.3458
	0.3492	0.3587		0.3468	0.3372
R8	0.3533	0.3620	RS	0.3504	0.3398
	0.3524	0.3554		0.3514	0.3487

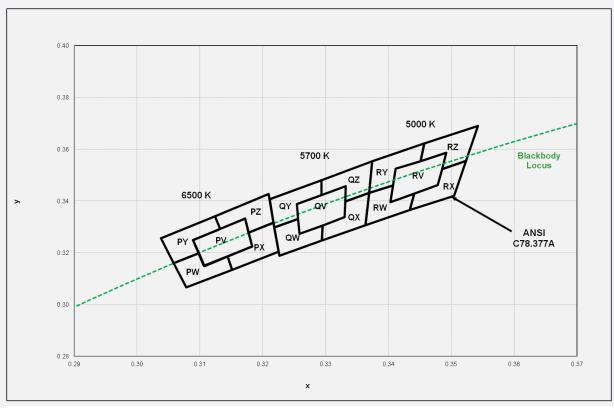
Region	CIE x	CIE y	Region	CIE x	CIE y
		Q rank	(5700 K)		
	0.3218	0.3298		0.3211	0.3407
Q1	0.3222	0.3243	00	0.3215	0.3353
Qı	0.3258	0.3275	Q9	0.3254	0.3388
	0.3256	0.3331		0.3252	0.3444
	0.3256	0.3331		0.3252	0.3444
00	0.3258	0.3275	0.4	0.3254	0.3388
Q2	0.3294	0.3306	QA	0.3293	0.3423
	0.3294	0.3364		0.3293	0.3481
	0.3294	0.3364		0.3293	0.3481
00	0.3294	0.3306	0.5	0.3293	0.3423
Q3	0.3330	0.3338	QB	0.3332	0.3458
	0.3331	0.3398		0.3333	0.3518
	0.3331	0.3398		0.3333	0.3518
	0.3330	0.3338	QC	0.3332	0.3458
Q4	0.3366	0.3369		0.3371	0.3493
	0.3369	0.3431		0.3374	0.3554
	0.3215	0.3353		0.3222	0.3243
0-	0.3218	0.3298	0.5	0.3227	0.3180
Q5	0.3256	0.3331	QP	0.3260	0.3208
	0.3254	0.3388		0.3258	0.3275
	0.3254	0.3388		0.3258	0.3275
	0.3256	0.3331		0.3260	0.3208
Q6	0.3294	0.3364	QQ	0.3294	0.3235
	0.3293	0.3423		0.3294	0.3306
	0.3293	0.3423		0.3294	0.3306
0-	0.3294	0.3364	0.5	0.3294	0.3235
Q7	0.3331	0.3398	QR	0.3330	0.3266
	0.3332	0.3458		0.3330	0.3338
	0.3332	0.3458		0.3330	0.3338
	0.3331	0.3398		0.3330	0.3266
Q8	0.3369	0.3431	QS	0.3364	0.3292
	0.3371	0.3493		0.3366	0.3369

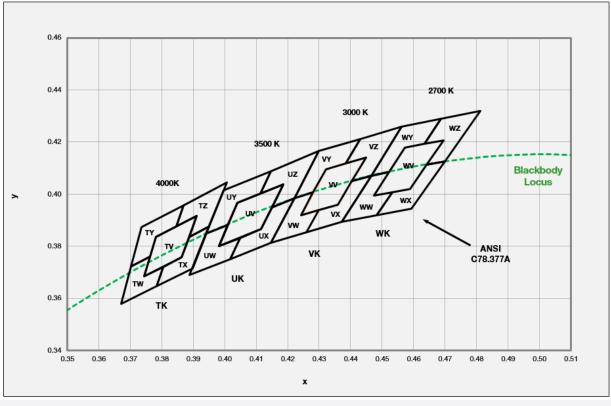
e) Chromaticity Region & Coordinates

Region	CIE x	CIE y	Region	CIE x	CIE y
		P rank	(6500 K)		
	0.3079	0.3060		0.3058	0.316
	0.3115	0.3098		0.3098	0.3199
PP	0.3106	0.3150	P5	0.3089	0.3249
	0.3068	0.3113		0.3048	0.3207
	0.3115	0.3098		0.3098	0.3199
	0.3152	0.3133		0.3137	0.3238
PQ	0.3144	0.3186	P6	0.313	0.329
	0.3106	0.3150		0.3089	0.3249
	0.3152	0.3133		0.3137	0.3238
	0.3190	0.3170		0.3177	0.3278
PR	0.3183	0.3224	P7	0.3172	0.3332
	0.3144	0.3186		0.313	0.329
	0.3190	0.3170		0.3177	0.3278
	0.3225	0.3200	P8	0.3217	0.3317
PS	0.3221	0.3261		0.3213	0.3373
	0.3183	0.3224		0.3172	0.3332
	0.3068	0.3113		0.3048	0.3207
	0.3106	0.315		0.3089	0.3249
P1	0.3098	0.3199	P9	0.308	0.3298
	0.3058	0.316		0.3038	0.3256
	0.3106	0.315		0.3089	0.3249
	0.3144	0.3186		0.313	0.329
P2	0.3137	0.3238	PA	0.3123	0.3341
	0.3098	0.3199		0.308	0.3298
	0.3144	0.3186		0.313	0.329
	0.3183	0.3224		0.3172	0.3332
P3	0.3177	0.3278	PB	0.3166	0.3384
	0.3137	0.3238		0.3123	0.3341
	0.3183	0.3224		0.3172	0.3332
	0.3221	0.3261		0.3213	0.3373
P4	0.3217	0.3317	PC	0.3209	0.3427
	0.3177	0.3278		0.3166	0.3384

Note: Samsung maintains measurement tolerance of : Cx, Cy = ± 0.005

f) Kitting Chromaticity Region & Coordinates ($I_F = 65 \text{ mA}$, $T_s = 25 \, ^{\circ}\text{C}$)





f) Kitting Chromaticity Region & Coordinates (I_F = 65 mA, T_s = 25 °C)

Region	CIE x	CIE y	Region	CIE x	CIE y					
	W rank (2700 K)									
	0.4475	0.3994								
WV	0.4589	0.4021								
VVV	0.4695	0.4207								
	0.4573	0.4178								
	0.4373	0.3893		0.4465	0.4071					
	0.4483	0.3919	WY	0.4523	0.4085					
WW	0.4532	0.4008		0.4573	0.4178					
VVVV	0.4475	0.3994		0.4634	0.4193					
	0.4523	0.4085		0.4687	0.4289					
	0.4465	0.4071		0.4562	0.4260					
	0.4483	0.3919		0.4641	0.4112					
	0.4593	0.3944		0.4700	0.4126					
WX	0.4700	0.4126	\\/Z	0.4813	0.4319					
VVX	0.4641	0.4112	WZ	0.4687	0.4289					
	0.4589	0.4021		0.4634	0.4193					
	0.4532	0.4008		0.4695	0.4207					

Region	CIE x	CIE y	Region	CIE x	CIE y					
	V rank (3000 K)									
	0.4242	0.3919								
VV	0.4359	0.3960								
VV	0.4449	0.4141								
	0.4322	0.4096								
	0.4147	0.3814		0.4221	0.3984					
	0.4259	0.3853		0.4281	0.4006					
VW	0.4300	0.3939	VY	0.4322	0.4096					
VVV	0.4242	0.3919	VI	0.4385	0.4119					
	0.4281	0.4006		0.4430	0.4212					
	0.4221	0.3984		0.4299	0.4165					
	0.4259	0.3853		0.4403	0.4049					
	0.4373	0.3893		0.4465	0.4071					
VX	0.4465	0.4071	VZ	0.4562	0.4260					
VX	0.4403	0.4049	۷۷	0.4430	0.4212					
	0.4359	0.3960		0.4385	0.4119					
	0.4300	0.3939		0.4449	0.4141					

f) Kitting Chromaticity Region & Coordinates

Region	CIE x	CIE y	Region	CIE x	CIE y				
U rank (3500 K)									
	0.3981	0.3800							
UV	0.4116	0.3865							
UV	0.4186	0.4037							
	0.4040	0.3966							
	0.3889	0.3690		0.3941	0.3848				
	0.4017	0.3751	UY	0.4010	0.3882				
UW	0.4048	0.3832		0.4040	0.3966				
OVV	0.3981	0.3800		0.4113	0.4001				
	0.4010	0.3882		0.4146	0.4089				
	0.3941	0.3848		0.3996	0.4015				
	0.4017	0.3751		0.4150	0.3950				
	0.4147	0.3814		0.4221	0.3984				
UX	0.4221	0.3984	UZ	0.4299	0.4165				
UX	0.4150	0.3950	UZ	0.4146	0.4089				
	0.4116	0.3865		0.4113	0.4001				
	0.4048	0.3832		0.4186	0.4037				

Region	CIE x	CIE y	Region	CIE x	CIE y					
	T rank (4000 K)									
	0.3744	0.3685								
TV	0.3863	0.3758								
IV	0.3912	0.3917								
	0.3782	0.3837								
	0.3670	0.3578		0.3702	0.3722					
	0.3783	0.3646	TY	0.3763	0.3760					
TW	0.3804	0.3721		0.3782	0.3837					
IVV	0.3744	0.3685		0.3847	0.3877					
	0.3763	0.3760		0.3869	0.3958					
	0.3702	0.3722		0.3736	0.3874					
	0.3783	0.3646		0.3887	0.3837					
	0.3898	0.3716		0.3950	0.3875					
TX	0.3950	0.3875	TZ	0.4006	0.4044					
1.7	0.3887	0.3837	12	0.3869	0.3958					
	0.3863	0.3758		0.3847	0.3877					
	0.3804	0.3721		0.3912	0.3917					

f) Kitting Chromaticity Region & Coordinates

Region	CIE x	CIE y	Region	CIE x	CIE y		
	R rank (5000 K)						
	0.3403	0.3398					
RV	0.3477	0.3458					
ΚV	0.3492	0.3587					
	0.3411	0.3522					
	0.3364	0.3292	RY	0.3369	0.3431		
5.44	0.3434	0.3344		0.3407	0.346		
	0.344	0.3427		0.3411	0.3522		
RW	0.3403	0.3398		0.3451	0.3554		
	0.3407	0.346		0.3457	0.3621		
	0.3369	0.3431		0.3374	0.3553		
	0.3434	0.3344	RZ	0.3485	0.3522		
	0.3504	0.3398		0.3524	0.3554		
RX	0.3524	0.3554		0.3542	0.369		
KX	0.3485	0.3522		0.3457	0.3621		
	0.3477	0.3458		0.3451	0.3554		
	0.344	0.3427		0.3492	0.3587		

Region	CIE x	CIE y	Region	CIE x	CIE y		
	Q rank (5700 K)						
	0.3258	0.3275					
QV	0.333	0.3338					
Qv	0.3332	0.3458					
	0.3254	0.3388					
	0.3227	0.318	QY	0.3218	0.3298		
	0.3294	0.3235		0.3256	0.3331		
QW	0.3294	0.3306		0.3254	0.3388		
Qvv	0.3258	0.3275		0.3293	0.3423		
	0.3256	0.3331		0.3293	0.3481		
	0.3218	0.3298		0.3211	0.3407		
	0.3294	0.3235		0.3293	0.3423		
	0.3364	0.3292		0.3332	0.3458		
QX	0.3369	0.3431	QZ	0.3331	0.3398		
Q۸	0.3331	0.3398	ŲΔ	0.3369	0.3431		
	0.333	0.3338		0.3374	0.3554		
	0.3294	0.3306		0.3293	0.3481		

f) Kitting Chromaticity Region & Coordinates

Region	CIE x	CIE y	Region	CIE x	CIE y		
	P rank (6500 K)						
	0.3106	0.315					
PV	0.3183	0.3224					
FV	0.3172	0.3332					
	0.3089	0.3249					
	0.3079	0.306	PY	0.3058	0.316		
	0.3152	0.3133		0.3098	0.3199		
PW	0.3144	0.3186		0.3089	0.3249		
PVV	0.3106	0.3150		0.313	0.329		
	0.3098	0.3199		0.3123	0.3341		
	0.3058	0.3160		0.3038	0.3256		
	0.3152	0.3133		0.313	0.329		
	0.3225	0.32		0.3172	0.3332		
PX	0.3217	0.3317	PZ	0.3177	0.3278		
17	0.3177	0.3278	1 4	0.3217	0.3317		
	0.3183	0.3224		0.3209	0.3427		
	0.3144 0.3186			0.3123	0.3341		

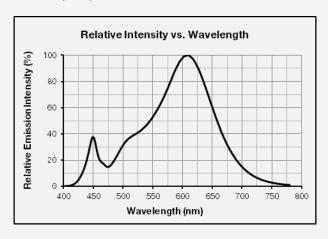
Note:

Samsung maintains measurement tolerance of: Cx, $Cy = \pm 0.005$

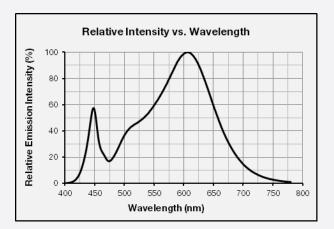
3. Typical Characteristics Graphs

a) Spectrum Distribution (I_F = 65 mA, T_s = 25 °C)

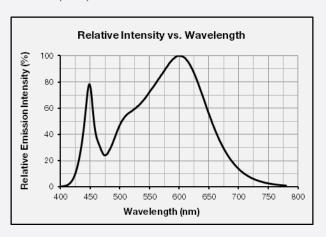
CCT: 2700 K (90 CRI)



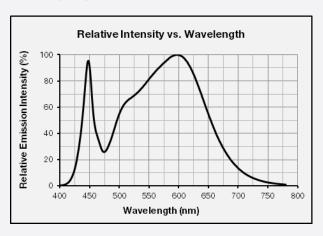
CCT: 3000 K (90 CRI)



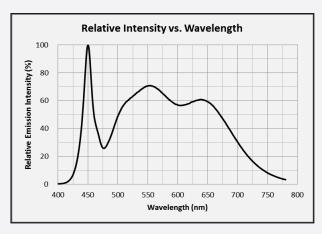
CCT: 3500 K (90 CRI)



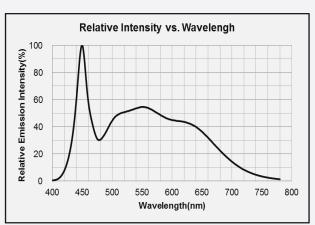
CCT: 4000 K (90 CRI)



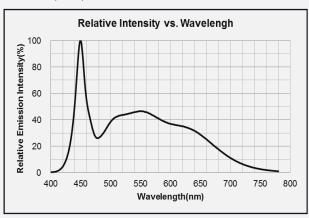
CCT: 5000 K (90 CRI)



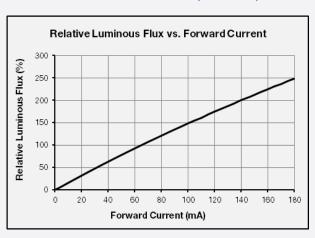
CCT: 5700 K (90 CRI)

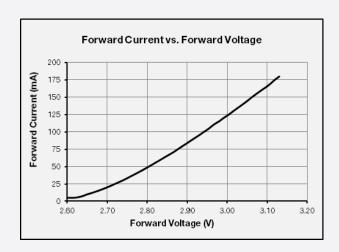


CCT: 6500 K (90 CRI)

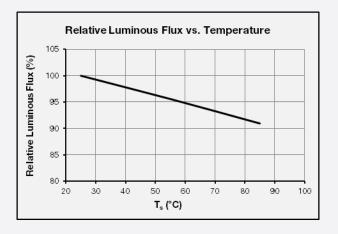


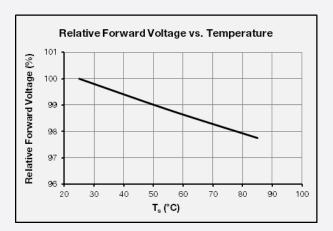
b) Forward Current Characteristics (T_s = 25 °C)





c) Temperature Characteristics (I_F = 65 mA)

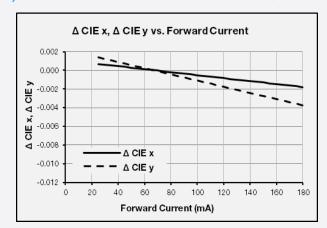


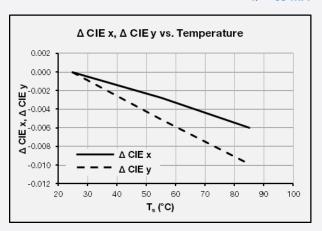


d) Color Shift Characteristics

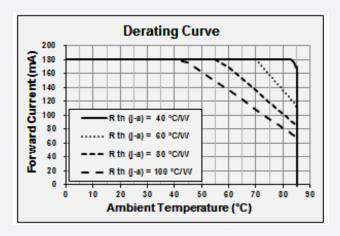
 $T_s = 25 \, {}^{\circ}C$



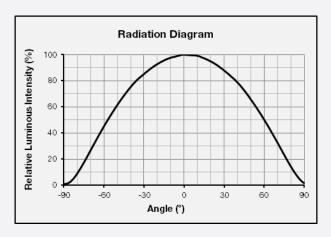




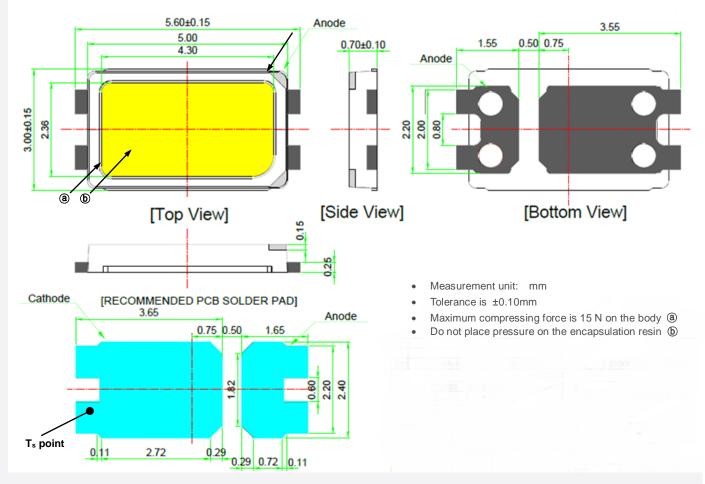
e) Derating Curve



f) Beam Angle Characteristics ($I_F = 65 \text{ mA}$, $T_s = 25 \text{ }^{\circ}\text{C}$)



4. Outline Drawing & Dimension



Notes:

- 1) This LED has built-in ESD protection device(s) connected in parallel to LED chip(s).
- 2) T_s point and measurement method:
 - 1) Measure one point at the cathode pad, if necessary remove PSR of PCB to reach T_s point.
 - (2) All pads must be soldered to the PCB to dissipate heat properly, otherwise the LED can be damaged.

Precautions:

- 1) Pressure on the LEDs will influence to the reliability of the LEDs. Precautions should be taken to avoid strong pressure on the LEDs. Do not put stress on the LEDs during heating.
- 2) Re-soldering should not be done after the LEDs have been soldered. If re-soldering is unavoidable, LED's characteristics should be carefully checked before and after such repair.
- 3) Do not stack assembled PCBs together. Since materials of LEDs is soft, abrasion between two PCB assembled with LED might cause catastrophic failure of the LEDs.

5. Reliability Test Items & Conditions

a) Test Items

Test Item	Test Condition	n	Test Hour / Cycle	Sample No.
High Temperature Life Test	85 °C, DC 180 n	nA	1000 h	22
High Temperature Humidity Life Test	60 °C, 90 % RH, DC	180 mA	1000 h	22
Powered Temperature Cycle Test	-40 °C / 10 min ↔ 85 °C / 10 m cycle on/off: each 5 min,		100 cycles	22
Thermal Cycle	-45 °C / 15 min ↔ 125 ° → Hot plate 180		500 cycles	100
High Temperature Storage	120 °C		1000 h	11
Low Temperature Storage	-40 °C		1000 h	11
ESD (HBM)	R ₁ Q S ₁	$\begin{array}{ll} R_1: & 10 \ M\Omega \\ R_2: & 1.5 \ k\Omega \\ C: & 100 \ pF \\ V: & \pm 5 \ kV \end{array}$	5 times	30
ESD (MM)	Ov †c [D.U.T.]	R ₁ : 10 MΩ R ₂ : 0 C: 200 pF V: ±0.5 kV	5 times	30
Vibration Test	20~2000~20 Hz, 200 m/s², sweep 4 min X, Y, Z 3 direction, each 1 cycle		4 cycles	11
Mechanical Shock Test	1500 g, 0.5 ms 3 shocks each X-Y-Z axis		5 cycles	11

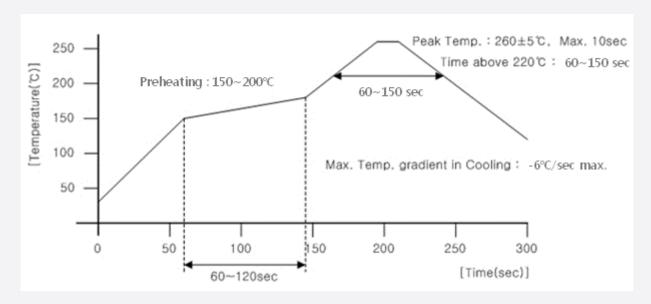
b) Criteria for Judging the Damage

Item	Symbol	Test Condition	Limit		
item	Symbol	(T _s = 25 °C)	Min	Max	
Forward Voltage	V _F	$I_F = 65 \text{ mA}$	Init. Value * 0.9	Init. Value * 1.1	
Luminous Flux	Φν	I _F = 65 mA	Init. Value * 0.7	Init. Value * 1.1	

6. Soldering Conditions

a) Reflow Conditions (Pb free)

Reflow frequency: 2 times max.



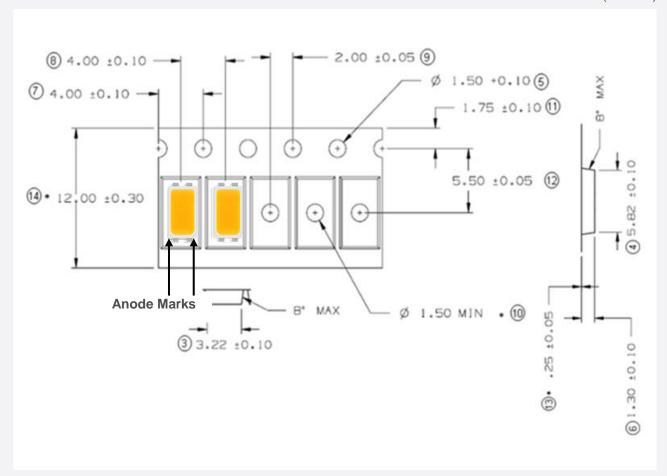
b) Manual Soldering Conditions

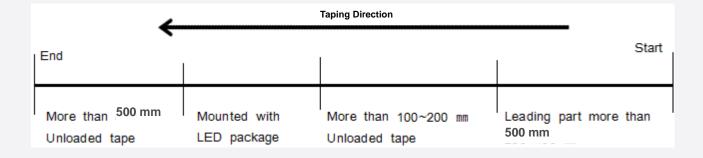
Not more than 5 seconds @ max. 300 °C, under soldering iron.

7. Tape & Reel

a) Taping Dimension

(unit: mm)





b) Reel Dimension (Max 2,500 pcs)

Ø 180±0.3

Ø 180±0.3

Ø 10

Ø 10

Ø 10

Ø 10

Ø 10

Ø 10

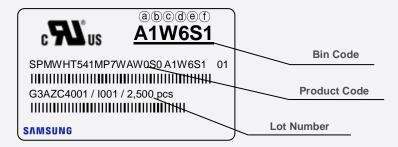
(unit: mm)

Notes:

- 1) Quantity: The quantity/reel is 2,500
- 2) Cumulative Tolerance: Cumulative tolerance / 10 pitches is ±0.2 mm
- 3) Adhesion Strength of Cover Tape: Adhesion strength is 0.1-0.7 N when the cover tape is turned off from the carrier tape at 10° angle to the carrier tape
- 4) Packaging: P/N, Manufacturing data code no. and quantity are indicated on the aluminum packing bag

8. Label Structure

a) Label Structure



Note: Denoted bin code and product code above is only an example (see description on page 5)

Bin Code:

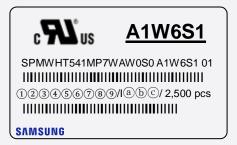
(refer to page 10)

©d: Chromaticity bin (refer to page 9)

(e) f): Luminous Flux bin (refer to page 6)

b) Lot Number

The lot number is composed of the following characters:



① 3456789 / Iabc / 2,500 pcs

1, 2 : Production site (GL: Tianjin, China, G3: Shenzhen, China, G4: Guangzhou, China)

3 : Product state (A: Normal, B: Bulk, C: First Production, R: Reproduction, S: Sample)

④ : Year (Z: 2015, A: 2016, B: 2017, C:2018...)

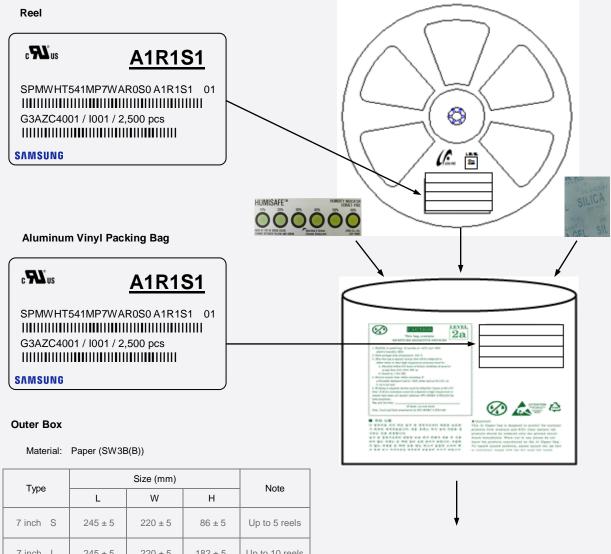
⑤ : Month (1~9, A, B, C)

6789 : Day (1~9, A, B~V)

(a)b)C : Product serial number (001 ~ 999)

9. Packing Structure

a) Packing Process (The quantity of PKG on the Reel to be Max 2,500pcs)



Type		Note		
Туре	L	W	Н	Note
7 inch S	245 ± 5	220 ± 5	86 ± 5	Up to 5 reels
7 inch L	245 ± 5	220 ± 5	182 ± 5	Up to 10 reels

Label attached position SAMSUNG Η **LED** L

c**W**us

A1R1S1

SPMWHT541MP7WAR0S0A1R1S1 01 G3AZC4001 / I001 / 25,000 pcs SAMSUNG [Box Label]

b) Packing Process for kitting (The quantity of PKG on the Reel to be Max 2,500pcs)

Kitting 'A' Kitting 'B' Reel Kitting 'A' Kitting 'B' c**FL**°us c**W**us 0 0 SPMWHT541MP7WAQKS1 A1Q1S1 01 SPMWHT541MP7WAQKS1 A1QGS1 01 lin 🖺 G3AW94001 / I001 / 2,500 pcs G3AW94001 / I001 / 2,500 pcs **SAMSUNG** SAMSUNG **Aluminum Vinyl Packing Bag** Kitting 'A' Kitting 'B' OOOOO 000000 **A1⊘WS1** A1♦ZS1 c**SU**°us c**FL**°us SPMWHT541MP7WAQKS1 A1QGS1 01 SPMWHT541MP7WA \diamondsuit KS1 A1 \diamondsuit 1S1 01 G3AW94001 / I001 / 2,500 pcs G3AW94001 / I001 / 2,500 pcs Ø 🛵 🙃 SAMSUNG SAMSUNG Note: "♦" can be Nominal CCT code. Label attached position Η CHIP LED

Outer Box

Material: Paper (SW3B(B))

Turno		Note			
Туре	Type L W		Н	Note	
7 inch L	245 ± 5	220 ± 5	182 ± 5	Up to 10 reels	

SAMSUNG

LED

c) Aluminum Vinyl Packing Bag



CAUTION



This bag contains MOISTURE SENSITIVE DEVICES

- Shelf life in sealed bag: 12 months at <40°C and <90% relative humidity (RH)
- 2. Peak package body temperature: 240 °C
- After this bag is opened, devices that will be subjected to reflow soldor or other high temperature processes must be:
 - a. Mounted within 672 hours at factory conditions of equal to or less than 30°C /60% RH, or
 - b. Stored at < 10% RH
- 4. Devices require bake, before mounting, if:
 - a.Humidity Indicator Card is > 60% when read at 23±5°C, or b. 2a is not met.
- 5. If baking is required, devices must be baked for 10~24 hours at 60±5°C Note: if device containers cannot be subjected to high temperature or shorter bake times are desired, reference IPC/JEDEC J-STD-033 for bake procedure.

Bag seal due date: ___

(T blank, see code label)

Note: Level and body temperature by IPC/JEDEC J-STD-020

A1W6S1

SAMSUNG









■ 주의 사항

이 알루미늄 지퍼 백은 습기 및 정전기로부터 제품을 보호하 기 위하여 제작되었습니다. 개봉 후에는 즉시 솔더 작업을 실 시하는 것을 권장합니다.

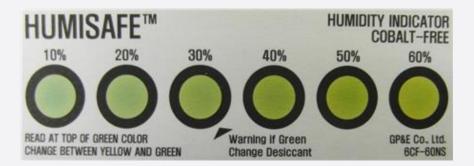
습기 및 정전기로부터 제품을 보호 하기 위해서 개봉 후 사용 하지 않는 자재는 본 팩에 넣어 보관 하시기 바랍니다. 사용하 지 않는 자재를 본 팩에 넣을 때는 반드시 동봉된 드라이 팩 과 함께 넣고 지퍼부분을 완전하게 밀봉하여 주시기 바랍니다.

■ Important

This Al Zipper bag is designed to protect the enclosed products from moisture and ESD. Once opened, the products should be soldered onto the printed circuit board immediately. When not in use, please do not leave the products unprotected by the Al Zipper Bag. To repack unused products., please ensure the zip-lock is completely sealed with the dry pack left inside.

d) Silica Gel & Humidity Indicator Card inside Aluminum Vinyl Bag (This image is for reference only, silicagel and humidity indicator shapes may be different.)





10. Precautions in Handling & Use

- 1) For over-current protection, users are recommended to apply resistors connected in series with the LEDs to mitigate sudden change of the forward current caused by shift of forward voltage.
- 2) This device should not be used in any type of fluid such as water, oil, organic solvent, etc. When cleaning is required, IPA is recommended as the cleaning agent. Some solvent-based cleaning agent may damage the silicone resins used in the device
- 3) When the device is in operation, the forward current should be carefully determined considering the maximum ambient temperature and corresponding junction temperature.
- 4) LEDs must be stored in a clean environment. If the LEDs are to be stored for three months or more after being shipped from Samsung, they should be packed with a nitrogen-filled container (shelf life of sealed bags is 12 months at temperature 0~40 °C, 0~90 % RH).
- 5) After storage bag is opened, device subjected to soldering, solder reflow, or other high temperature processes must be:
 - a. Mounted within 672 hours (28 days) at an assembly line with a condition of no more than 30 °C / 60 % RH, or
 - b. Stored at <10 % RH
- 6) Repack unused devices with anti-moisture packing, fold to close any opening and then store in a dry place.
- 7) Devices require baking before mounting, if humidity card reading is >60 % at $23 \pm 5 \degree$ C.
- 8) Devices must be baked for $10\sim24$ hours at 60 ± 5 °C, if baking is required.
- 9) The LEDs are sensitive to the static electricity and surge current. It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs. If voltage exceeding the absolute maximum rating is applied to LEDs, it may cause damage or even destruction to LED devices. Damaged LEDs may show some unusual characteristics such as increase in leakage current, lowered turn-on voltage, or abnormal lighting of LEDs at low current.
- 10) VOCs (Volatile Organic Compounds) can be generated from adhesives, flux, hardener or organic additives used in luminaires (fixtures). Transparent LED silicone encapsulant is permeable to those chemicals and they may lead to a discoloration of encapsulant when they exposed to heat or light. This phenomenon can cause a significant loss of light emitted (output) from the luminaires. In order to prevent these problems, we recommend users to know the physical properties of materials used in luminaires and they must be carefully selected.
- 11) Risk of sulfurization (or tarnishing)
 - The LED from Samsung uses a silver-plated lead frame and its surface color may change to black (or dark colored) when it is exposed to sulfur (S), chlorine (Cl) or other halogen compound. Sulfurization of lead frame may cause intensity degradation, change of chromaticity coordinates and, in extreme cases, open circuit. It requires caution. Due to possible

sulfurization of lead frame, LED should not be used and stored together with oxidizing substances made of materials such as rubber, plain paper, lead solder cream, etc.

Legal and additional information.

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Samsung inspires the world and shapes the future with transformative ideas and technologies.

The company is redefining the worlds of TVs, smartphones, wearable devices, tablets, digital appliances, network systems, and memory, system LSI, foundry and LED solutions

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